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#### November 2013

## RHRP3060 30 A, 600 V Hyperfast Diodes

### Features

- Hyperfast Recovery trr = 45 ns (@ I<sub>F</sub> = 30 A)
- Max Forward Voltage, VF = 2.1 V (@ Tc = 25°C)
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

## Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

## **Ordering Informations**

Part Number	Package	Brand
RHRP3060	TO-220AC-2L	RHRP3060

## **Pin Assignments**





The RHRP3060 is a hyperfast diode with soft recovery characteristics. It has the half recovery time of ultrafast

diodes and is silicon nitride passivated ionimplanted

variety of switching power supplies and other power

switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise

epitaxial planar construction. These devices are intended to be used as freewheeling clamping diodes and diodes in a

in many power switching circuits reducing power loss in the

Description

switching transistors.

1. Cathode 2. Anode

## **Absolute Maximum Ratings**

Symbol	Parameter	RHRP3060	Unit	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	600	V	
V <sub>RWM</sub>	Working Peak Reverse Voltage	600	V	
V <sub>R</sub>	DC Blocking Voltage	600	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current (T <sub>C</sub> = 120°C)	30	A	
I <sub>FRM</sub>	Repetitive Peak Surge Current (Square Wave, 20KHz)	70	А	
I <sub>FSM</sub>	Nonrepetitive Peak Surge Current (Halfwave, 1 Phase, 60Hz)	325	А	
P <sub>D</sub>	Maximum Power Dissipation	125	W	
E <sub>AVL</sub>	Avalanche Energy (See Figures 10 and 11)	20	mJ	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature -65 to 175		°C	

<b>Electrical Characteristics</b>	T <sub>C</sub> = 25°C unless otherwise noted
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Symbol	Test Conditions		RHRP3060		
	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	I <sub>F</sub> = 30 A	-	-	2.1	V
I <sub>F</sub> = 30 A, T <sub>C</sub> = 150°C		-	-	1.7	V
I <sub>R</sub>	V <sub>R</sub> = 400 V		-	-	μA
	V <sub>R</sub> = 600 V	-	-	250	μA
	V <sub>R</sub> = 400 V, T <sub>C</sub> = 150°C	-	-	-	mA
	V <sub>R</sub> = 600 V, T <sub>C</sub> = 150°C	-	-	1.0	mA
t <sub>rr</sub>	I <sub>F</sub> = 1 A, dI <sub>F</sub> /dt = 200 A/μs	-	-	40	ns
	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 200 A/μs	-	-	45	ns
t <sub>a</sub>	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 200 A/μs	-	22	-	ns
t <sub>b</sub>	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 200 A/μs	-	18	-	ns
Q <sub>RR</sub>	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 200 A/μs	-	100	-	nC
CJ	V <sub>R</sub> = 600 V, I <sub>F</sub> = 0 A	-	85	-	pF
R <sub>0JC</sub>		-	-	1.2	°C/W

DEFINITIONS

 $V_F$  = Instantaneous forward voltage (pw = 300  $\mu s,$  D = 2%)

I<sub>R</sub> = Instantaneous reverse current.

 $t_{rr}$  = Reverse recovery time (See Figure 9), summation of  $t_a$  +  $t_b$ .

 $t_a$  = Time to reach peak reverse current (See Figure 9).

 $t_b$  = Time from peak  $I_{RM}$  to projected zero crossing of  $I_{RM}$  based on a straight line from peak  $I_{RM}$  through 25% of  $I_{RM}$  (See Figure 9).

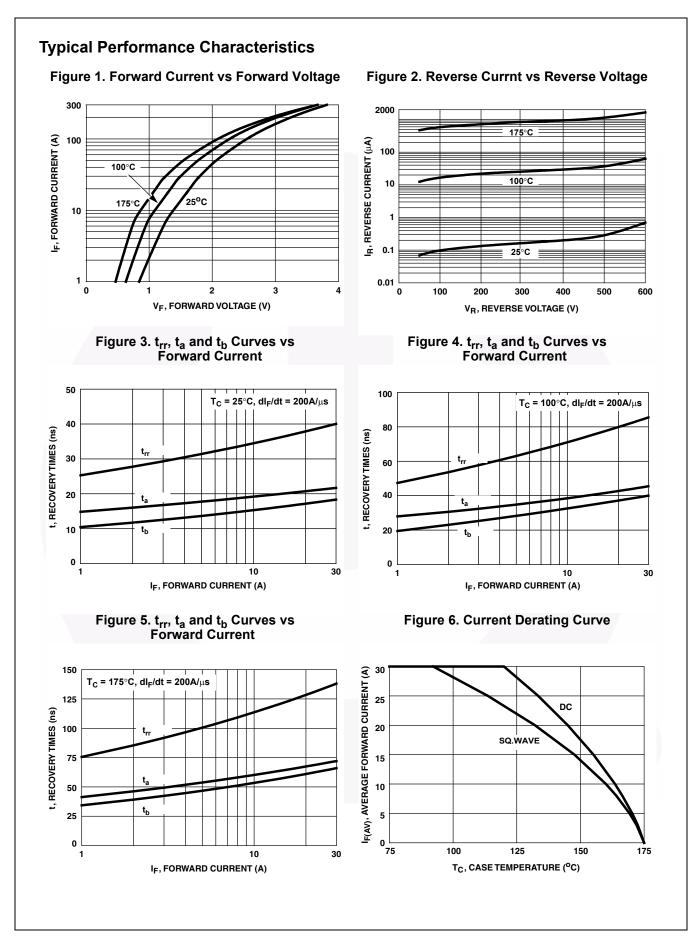
Q<sub>RR</sub> = Reverse recovery charge.

C<sub>J</sub> = Junction Capacitance.

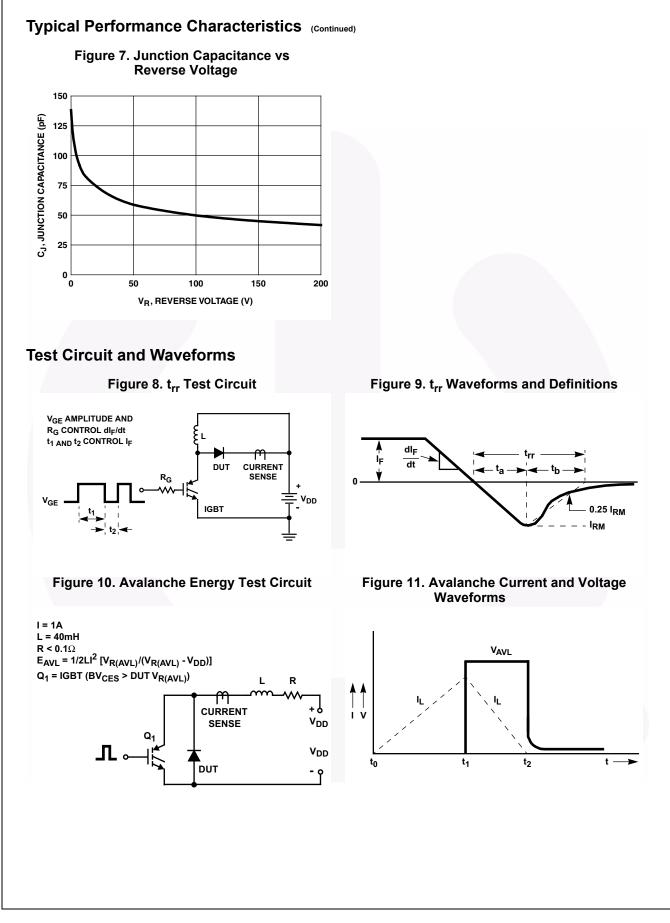
 $R_{\theta JC}$  = Thermal resistance junction to case.

pw = pulse width.

D = Duty cycle.



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RHRP3060 — Hyperfast Diode

Ø 4.09 3.50 ⊕ 0.36 M B A M 10.67 В Α 9.65 8.89 3.43 1.40 6.86 2.54 0.51 6.86 **7**° 5.84 3° T 13.40 16.51 12,19 14,22 16.15 9.40 15,75 8.38 **5**° **5°** 3° 3° 6.35 MAX 2 1 0.60 MAX С 14.73 13,60 1.65 (1.91)1.25 F Т 0.61 2.54 0.33 1.02 2.92 0.38 2.03 5.08 ⊕ 0.36 M C A B **5° 5°** 3° 3° ..... -...... FAIRCHILD ... 4.80 4.30

#### NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220,ISSUE K, VARIATION AC,DATED APRIL 2002.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DRAWING FILE NAME: TO220A02REV5



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Definition of Terms			
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.	
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